

Product Change Notification - KSRA-31LQPW108

Date:

02 Jun 2018

Product Category:

8-bit PIC Microcontrollers

Affected CPNs:



Notification subject:

CCB 3051 Final Notice: Qualification of ASE as an additional assembly site for selected Atmel products available in 100L TFBGA (9x9mm) package

Notification text:

PCN Status:

Final notification

PCN Type:

Manufacturing Change

Microchip Parts Affected:

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:

Qualification of ASE as an additional assembly site for selected Atmel products available in 100L TFBGA (9x9mm) package.

Pre Change:

Assembled at LPI assembly site

Post Change:

Assembled at LPI or ASE assembly site

Pre and Post Change Summary:

	Pre Change	Post Change					
	Lingsen Precision	Lingsen Precision					
Assembly Site	Industires, LTD.	Industires, LTD.	ASE Inc. (ASE)				
	(LPI)	(LPI)					
Wire material	Au wire	Au wire	Au wire				
Die attach material	2100	2100	2100				
Molding compound	G770H	G770H	KE-G1250NAS				
material	G770H	G/70H					
Substrate material	HL832NX(A-HS)	HL832NX(A-HS)	HL832NX(A-HS)				
Solder Ball	SAC 305	SAC 305	SAC 105				

Impacts to Data Sheet:

None

Change Impact:

None

Reason for Change:

To improve manufacturability by qualifying ASE as an additional assembly site.

Change Implementation Status:

In Progress



Estimated First Ship Date:

July 02, 2018 (date code: 1827)

Time Table Summary:

	September 2017				June 2018				July 2018							
Workweek	35	36	37	38	39	>	22	23	24	25	26	27	28	29	30	31
Initial PCN Issue				_												
Date				^												
Qual Report																
Availability							^									
Final PCN Issue Date							Χ									
Estimated Implementation Date												X				

Method to Identify Change:

Traceability code

Qualification Report:

Please open the attachments included with this PCN labeled as PCN_#_Qual Report.

Revision History:

September 18, 2017: Issued initial notification.

June 02, 2018: Issued final notification. Attached the Qualification Report. Revised the affected parts list. Provided estimated first ship date on July 02, 2018.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN_KSRA-31LQPW108_Qual Report.pdf

Please contact your local <u>Microchip sales office</u> with questions or concerns regarding this notification.

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Affected Catalog Part Numbers (CPN)

ATMEGA1280-16CU

ATMEGA1280-16CUR

ATMEGA1280V-8CU

ATMEGA1280V-8CUR

ATMEGA2560-16CU

ATMEGA2560-16CUA0

ATMEGA2560-16CUR

ATMEGA2560-16CURA0

ATMEGA2560V-8CU

ATMEGA2560V-8CUA0

ATMEGA2560V-8CUR

ATMEGA2560V-8CURA0

ATMEGA640-16CU

ATMEGA640-16CUR

ATMEGA640V-8CU

ATMEGA640V-8CUR

ATXMEGA128A1-CU

ATXMEGA128A1-CUA1

ATXMEGA128A1-CUR

ATXMEGA128A1U-CN

ATXMEGA128A1U-CNR

ATXMEGA128A1U-CU

ATXMEGA128A1U-CUR

ATXMEGA64A1-CU

ATXMEGA64A1-CUR

ATXMEGA64A1U-CU

ATXMEGA64A1U-CUR

ATXMEGA64A1U-CURA0

Date: Friday, June 01, 2018